

Compact Heat Exchangers for Nuclear Power Plants

Topical Workshop on New Cross-Cutting Technologies for Nuclear Power Plants

Session 2: Advanced Power Conversion for NPP

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Why Compact HXs?

TECHNOLOGY

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INSIGHTS



Why Compact HXs?



- At first glance compact HXs would seem to be the obvious choice
- However, there is much more that needs to be considered

(Source: Ref. 5)

TECHNOLOGY INSIGHTS Slide 3

Why Compact HXs?



- At first glance compact HXs would seem to be the obvious choice
- However, there is much more that needs to be considered
- The selection of HX technology is very much application dependent



Overview

- Functions and Requirements
- HX Types
- Metallic Heat Exchangers
- Ceramic Heat Exchangers
- Heat Exchanger Incentives and Challenges
- Summary Observations

Functions (What?)

- Direct flow of fluids
- Transfer thermal energy
- Maintain pressure boundary integrity
- Transfer loads (internal and external)

Representative Advanced HX Applications

| Application | Primary Fluid | Secondary Fluid | Max. Temp. (°C) | HX Class |
|-------------|------------------|------------------------|-----------------------|------------------------|
| SFR | Na | Na | 500 | IHX |
| SFR | Na | H ₂ O | 475 | SG |
| AHTR | FLiBe | Helium, Air, M-Salt | 700 | IHX |
| AHTR | M-Salt | H ₂ O | 670 | SG |
| HTGR-SC | Helium | H ₂ O | 750 | SG |
| HTGR-GT | Helium | N/A | 500 | Recuperator |
| HTGR-PH | Helium | Helium, M-Salt | 850-950 | IHX |
| HTGR-PH | Helium | Process Fluid | 800-900 | Process Coupling HX |

Requirements

(Under what conditions? How well?)

- Thermal rating
- Chemical composition and properties of fluids
 - Heat transfer properties
 - Compatibility with HX materials
- Temperatures, pressures, flow rates
- Steady state and transient operating conditions, design lifetime (duty cycle)
- Structural loadings
 - Internal (e.g. flow induced)
 - External (e.g. seismic, vibration)
- Reliability
 - Pressure boundary integrity requirements some variation with application (IHX vs. recuperator)
 - Maintaining performance fouling, channel blocking, bypass, etc.
- Maintainability
- Economic (initial cost plus contribution to plant O&M cost)

GT-MHR Nominal Operating Parameters



Plate-Fin Recuperator



(Source: Ref. 6)

PRISM IHX



| Type: Shell & Tube | |
|------------------------|--------|
| Rating (MWt): | 840 |
| Primary: Shell Side | |
| Fluid: | Sodium |
| T _{in} (°C): | 499 |
| T _{out} (°C): | 360 |
| W (m³/s): | 5.4 |
| Secondary: Tube Side | |
| Fluid: | Sodium |
| T _{in} (°C): | 326 |
| T _{out} (°C): | 477 |
| W (m³/s): | 5.1 |
| | |



PRISM SG





AHTR IHX



| Type: Shell & Tube | |
|------------------------|--------|
| Rating (MWt): | 900 |
| Primary: Shell Side | |
| Fluid: | FLiBe |
| T _{in} (°C): | 600 |
| T _{out} (°C): | 704 |
| W (m³/s): | 1.9 |
| Secondary: Tube Sid | e |
| Fluid: | FLiNaK |
| T _{in} (°C): | 570 |
| T _{out} (°C): | 670 |
| W (m³/s): | TBC |

(Source: Ref. 11)



HTGR SG







| Type: Shell & Helical Tub | De |
|---------------------------------------|------------------|
| Rating (MWt): | 352 |
| Primary: Shell Side | |
| Fluid: | Helium |
| Τ _{in} (° C): | 725 |
| T _{out} (°C): | 290 |
| P _{He} (MPa): | 7 |
| W (kg/s): | |
| Secondary: Tube Side | |
| Fluid: | H ₂ O |
| Τ _{in} (°C): | 193 |
| T _{out} (°C): | 585 |
| P _{steam} (MPa): | 16.5 |
| W (kg/s): | 130.5 |

TECHNOLOGY

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VHTR Process Heat Application



Brayton Energy Unit Cell Plate-Fin IHX



Printed Circuit Heat Exchanger (PCHE)



Capillary Tube Heat Exchanger



Strength of Metallic HX Materials at High Temperatures



(Note: 300khrs ~ 40 life at design capacity factor)

Corrosion at High Temperatures

- Primary side chemistry in VHTRs (<u>>850</u>°C) poses a challenge for compact metallic HXs due to thin crosssections (Ref. 7)
 - Plate-fin HX thickness: Fins 0.102 mm; Plates 0.38 mm
 - In PCHE, plates are typically <u>>0.5 mm</u>; however, flow channels reduce the effective thickness to a value comparable to the plates in the plate-fin design





- Data analyzed in Ref. 7 at 950°C suggest that the predicted depths of internal oxidation could approach or exceed material thickness after only a few years of exposure
- Alloy X had the greatest resistance to corrosion, but strength inferior to Alloy 617 at highest temperatures
 - May be best candidate at <850°C</p>



Ceramatec Ceramic (SiC) HX Concept



Ceramic HX Concepts





Unit cell of offset-fin

Liquid Si Injected composite plate HX (UC Berkley)



Ceramic HX Tradeoffs

Advantages

- Temperature capability comparable to VHTR reactor
- SiC is compatible with a wide range of working fluids
- Potentially inexpensive materials and manufacture

Challenges

- Integration with remainder of circuit (ceramic to metallic joints)
- Reliability (leak tightness, potential for brittle fracture)
- Significant development effort

Observation

3-D printing may provide basis for breakthrough in compact ceramic microchannel HXs

Characteristics of Typical Advanced HXs

| Characteristic | He Steam Generator | Recuperator | Na-Na IHX | He-He IHX | He-MS IHX |
|--|----------------------------|--|----------------------------|---|--|
| Typical HX Type | Shell & Tube | Plate-Fin | Shell & Tube | Plate-Fin; PCHE | PCHE, Capillary Tube |
| Compact HX | Optional | Required for Economic Viability | Optional | Required for Economic Viability | Optional? |
| Maximum Temperature | 700°C - 750°C | 500°C | 500°C | 850°C - 1000°C | 850°C - 1000°C |
| Pressure Differential | Large | Intermediate, potentially varying | Low | Low | Large |
| Materials | Alloy 800 | Alloy 800, Alloy X | SS | Alloy X, I-617, Ceramics | I-617, Ceramics |
| Materials Compatibility w/Working Fluid | Good | Good | Good | Metallics: Concern w/primary side corrosion (thin x- sections) Ceramics: Potentially good | Metallics: Concern w/primary & secondary side corrosion Ceramics: Potentially good |
| Pressure Boundary Integrity | High integrity required | Some leakage acceptable - degrades | High integrity required | High integrity required | High integrity required |
| Reliability/Lifetime | Good | Good | Good | Metallics: Life limited by creep, corrosion Ceramics: Potentially good | Metallics: Life limited by creep, corrosion Ceramics: Potentially good |
| Duty Cycle/Transients | ОК | Good | ОК | P-F: Good; PCHE: ? | ? |
| Economics | Higher \$/kWt | Good | ОК | Potentially good | Potentially good |
| Development Status | Current SOA | Current SOA | Current SOA | Developmental | Developmental |
| Additional Issues | | Channel blockage | | Channel blockage, Ceramic-metal joints | Channel blockage, Ceramic-metal joints |

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Closing Observations

- 1. Heat exchanger design selections must be driven by functions and requirements
 - Optimum designs will vary significantly with application and requirements
 - Compact HXs are essential for some applications, e.g., HTGR-GT recuperators, HTGR-PH IHX
 - In other applications, incentives are not so clear, e.g. SFR and AHTR IHX
- 2. Compact metallic HXs are practical to ~850°C in pressure balanced applications

Corrosion may govern life at higher temperatures

Closing Observations

- 4. Compact ceramic HXs would be potentially enabling for higher temperatures and for challenging working fluids
- 5. Advanced manufacturing (3-D Printing) may enhance potential for very high temperature compact HXs:
 - Reduction of wasted material during manufacture of PCHEs
 - ODS Alloys (current manufacturing processes degrade properties)
 - Ceramic HXs

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Compact Heat Exchangers for Nuclear Power Plants

BACKUP SLIDES



| Metric | Shell & Tube | Capillary Tube | PCHE | Plate-Fin & Prime Surface |
|----------------------------------|--|--|---|---|
| Cost/Performance Indic | ators | | | |
| Compactness (m²/m³ & MW/m³) | Poor | Intermediate | Good | Good |
| Calc t/MWt | 13.5 | 0.88 | 1.16 | 0.25 |
| Materials Utilization (t/MWt) | Poor: (13.5 t/MWt) Unlikely to be commercially viable | Good (0.9 t/MWt) | Good: (estimated to be 1.2 to 1.5 times plate-fin in final form; needs confirmation) | Best: (0.25 t/MWt) Most compact, least materials |
| Manufacturing Cost | Established manufacturing process | Manufacturing process looks to be very labor intensive and expensive. | Established manufacturing process, amenable to volume manufacturing | Established manufacturing process, amenable to volume manufacturing |
| State-of-the-Art | | | | |
| Experience Base | HTTR, German PNP Development | None | PBMR DPP Recuperator, other commercial products | Conventional GT recuperators |
| Design & Manufacturing | Proven designs and manufacturing processes. | Proposed tubesheet manufacturing process not obviously feasible. Shell- side baffling will be very difficult with very large numbers of very small tubes | Proven designs and manufacturing processes. | Proven designs and manufacturing processes. |

(Source: Ref. 7)

| Metric | Shell & Tube | Capillary Tube | PCHE | Plate-Fin & Prime Surface |
|------------------|---|--|---|---|
| Robustness | | | | |
| Normal operation | Best: Simple cylindrical geometry, stresses minimized in HT area. Header interfaces can be easily isolated from HT area. | Simple geometery of tubes a plus. Temperature effects on "tubesheet" unknown. | Good: Thicker plates; local debonding does not immediately affect pressure boundary. | Concern: Thin plates with brazed joints in pressure boundary; stress risers in pressure boundary joints (but normally operate in compession). Small material and braze defects more significant. |
| Transients | Good: Simple cylindrical geometry avoids stress concentrations in HT area. Potential issues in headers, tube/header interfaces. | "Tubesheet" and tube/tubesheet interfaces are potentially problematical | Differing thermal response characteristics of inner HT core vs. solid outer boundary surrounding HT core raises potential for higher transient thermal stresses vs. plate-in. | Best: Thin sections and flexible design minimizes the effects of transients. |

(Source: Ref. 7)



| Metric | Shell & Tube | Capillary Tube | PCHE | Plate-Fin & |
|--|--|--|---|--|
| Environmental Compatib | ility | • • | | |
| Coolant chemistry/ corrosion effects (Assumes PHTS on tube side or inside of compact HX cells, SHTS on shell/outside) | Best: Thick tubes provide maximum resistance | Favorable tube-side geometry. Intermediate section thickness and susceptibility to corrosion effects. | Intermediate section thickness and susceptibility to corrosion effects. Potential greater for "hideout" effects than tubular designs. | Worst: Thin plates and fins, potentially aggrevated by "hideout" locations, may be more susceptible to coolant chemistry effects. |
| Dust, erosion (Assumes PHTS on tube side or inside of compact HX cells, SHTS on shell/outside) | Best: Large tube IDs, thick tubes make dust/erosion an non-issue. | Intermediate: Will be more prone to dust collection due to smaller diameters, but low likelihood of direct impingement | More prone to dust deposition and erosion (small passages, potentially with features to enhance HT). PCHE cross-sections are thicker than plate- fin/prime surface. | More prone to dust deposition and erosion (small passages, with features to enhance HT). Fin cross-sections are thinner than PCHE cross- sections. |
| Tritium transport | Best: Thick tubes provide maximum resistance. | Intermediate. Thinner tubes | Worse. Average PCHE cross-sections thicker, but minimum cross-sections comparable to plate- fin/prime surface. | Worst: Thin plates provide least resistance to tritium transport. |
| Reliability & Integrity Man | agement (RIM) | | <u>.</u> | |
| Detection of degradation and/or leaks during operation (Assumed SHTS to PHTS pressure bias) | Equivalent. Essentially pres Indication of significant leak increased injection of SHTS | sure balanced during norma cage would be manifested as helium and increased withd | l operation with SHTS at slig inability to maintain higher rawal of PHTS helium. | htly higher pressure. SHTS pressure and/or |
| Detection of degradation and/or leaks during outages | Large tube diameters may allow internal inspection of individual tubes to assess condition. | Design allows access to individual tubes to identify presence of leaks. However, a lot of tubes | Leaks can be detected at module level with concept similar to that proposed for plate-fin | Concept developed to detect leaks at module level. |
| Leak location; isolation, repair or replacement of failed components | Design allows location of leaks in individual tubes and plugging. | Design allows location of leaks in individual tubes and plugging. However, a lot of tubes. | Leaks can be isolated at module level with concept similar to that proposed for plate-fin. | Concept developed to locate and isolate leaks at module level. |

(Source: Ref. 7)

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| Metric | Shell & Tube | Capillary Tube | PCHE | Plate-Fin & Prime Surface |
|---|--|--|--|--|
| HX Integration | | - | | • |
| Integration with Vessels & Piping | Headers and HX-vessel integration demon-strated (e.g., HTTR, German PNP) | Integration with piping needs further evaluation | OK (by inference from plate fin work). | ок |
| Compatibility with Multi- Stage IHX Designs | Large vessels tend to make less attractive | High manufacturing costs would make less attractive. | Compatible with multi- stage designs. | Compatible with multi- stage designs. |
| Compatibility with Multi- Module IHX Designs | Large tubes, headers likely incompatible with multi- module designs. | High manufacturing costs would make less attractive. | Compact cores are good match with multi-module designs. | Very compact cores are best match with multi- module designs. |
| Compatibility with Alternate HT Fluids (PHTS to SHTS) | Poor tube-side HT characteristics problematical for alternate gases with lower conductivity. Potentially best choice for LS designs with LS on tube side (drainable). Headers would be an issue for high- temperature outlet. | Poor tube-side HT characteristics problematical for alternate gases with lower conductivity. May be OK for LS designs with LS on tube side (drainable). Tubesheets would be an issue for high-temperature outlet. | Design provides flexibility for matching characteristics of differing HT fluids, including LS. May be difficult to develop drainable design for LS. | Likely not compatible with liquid salt HT fluids. Good flexibility for matching HT characteristics of alternate gases. |
| Design/Licensing | | | | |
| Code Basis for Design | Existing Sect VIII Code design basis for tubular geometries and likely header designs | Existing Section VIII Code design basis for tubes, but header design has no Code precedents. | No existing design Code basis | No existing design Code basis |

Typical GT Applications



DIRECT CYCLE

INDIRECT CYCLE



Typical Process Heat Application

